

# CONTROLLING CHARGE DOPING IN 2D MATERIALS

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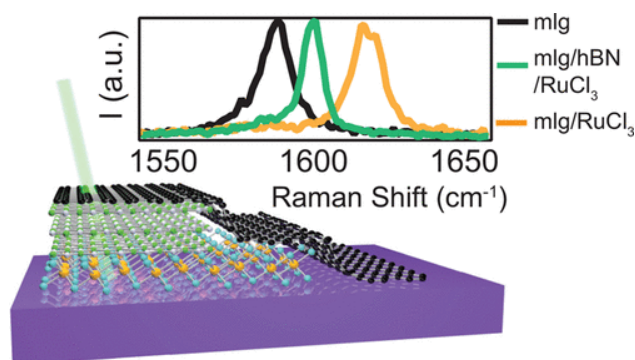
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## Technology Description

Researchers at Washington University in St. Louis have developed a method to control charge doping in 2D materials like graphene. This method uses  $\alpha$ -RuCl<sub>3</sub> to create pn junctions at a smaller scale than silicon transistors.

While  $\alpha$ -RuCl<sub>3</sub> efficiently removes electrons from graphene to create a charge-doped region, the effect can be mitigated by introducing layers of hexagonal boron nitride (hBN) between the two materials. This allows the charge doping to be precisely controlled and spatially-defined.



## Stage of Research

The researchers have constructed and extensively tested prototype devices using monolayer graphene, WSe<sub>2</sub> and EuS.

## Publications

- Wang Y, Balgley J, Gerber E, Gray M, ... Burch KS. (2020). [Modulation doping via a two-dimensional atomic crystalline acceptor](#). *Nano Letters*, 20(12): 8446-8452.

## Applications

- Construction of transistors from 2D materials (van der Waals heterostructures)

## Key Advantages

- Allows creation of transistors smaller than Si-based
- Applicable to multiple 2D materials: graphene, WSe<sub>2</sub>, EuS, etc.

**Patents:** Pending

**Related Web Links:** Henriksen [Profile](#) & [Lab](#)